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MITSUBISHI <INTELLIGENT POWER MODULES>

# PM75B5LB060

FLAT-BASE TYPE  
INSULATED PACKAGE

## PM75B5LB060



### FEATURE

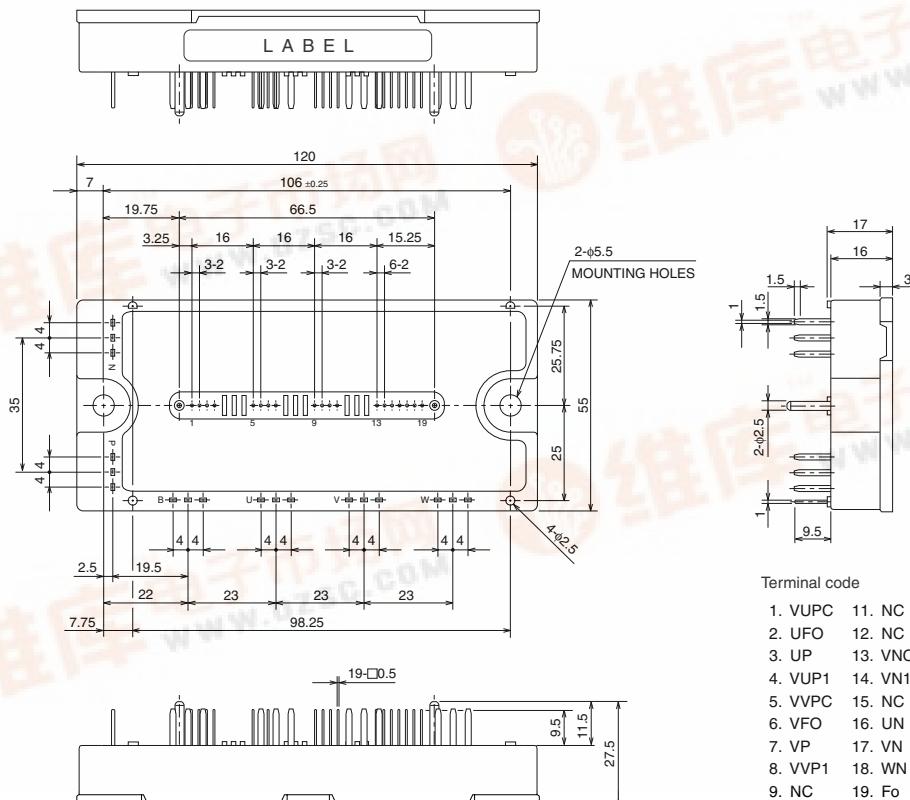
- a) Adopting new 5th generation IGBT (CSTBT™) chip, which performance is improved by 1μm fine rule process.  
For example, typical  $V_{ce}(\text{sat})=1.55\text{V}$  @ $T_j=125^\circ\text{C}$
- b) Over-temperature protection by detecting  $T_j$  of the CSTBT™ chips and error output is possible from all each conservation upper and lower arm of IPM.
- c) New small package  
Reduce the package size by 10%, thickness by 22% from S-DASH series.
  - 2φ 75A, 600V Current-sense IGBT type inverter
  - 75A, 600V Current-sense Chopper IGBT
  - Monolithic gate drive & protection logic
  - Detection, protection & status indication circuits for, short-circuit, over-temperature & under-voltage (P-Fo available from upper arm devices)
  - UL Recognized Yellow Card No.E80276(N)  
File No.E80271

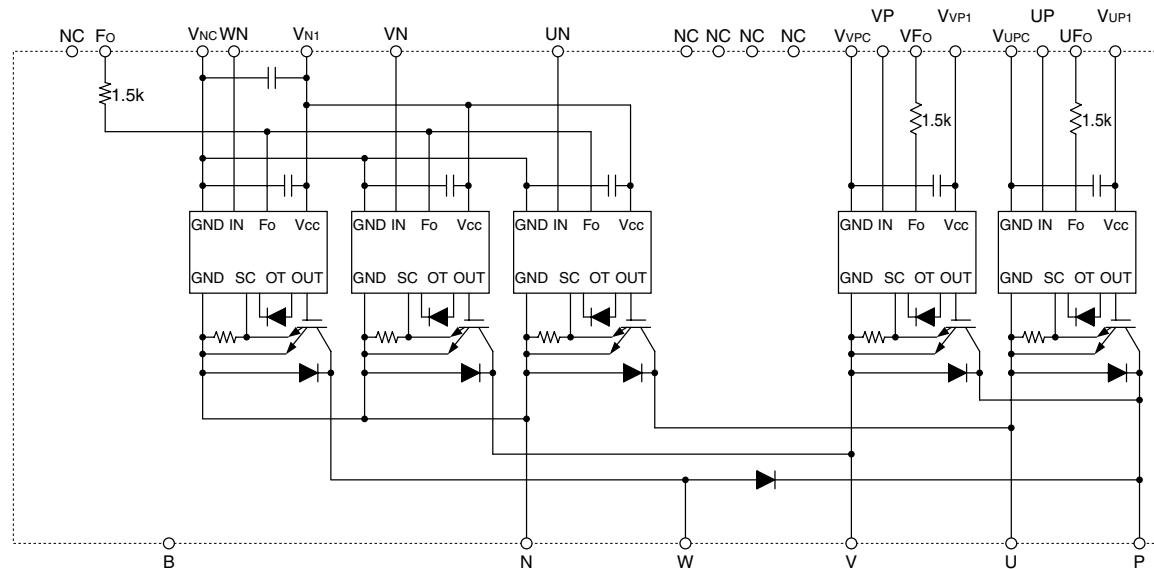
## APPLICATION

Photo voltaic power conditioner

### PACKAGE OUTLINES

Dimensions in mm



**PM75B5LB060**FLAT-BASE TYPE  
INSULATED PACKAGE**INTERNAL FUNCTIONS BLOCK DIAGRAM****MAXIMUM RATINGS (T<sub>j</sub> = 25°C, unless otherwise noted)****INVERTER PART**

Symbol	Parameter	Condition	Ratings	Unit
V <sub>CES</sub>	Collector-Emitter Voltage	V <sub>D</sub> = 15V, V <sub>CIN</sub> = 15V	600	V
±I <sub>C</sub>	Collector Current	T <sub>c</sub> = 25°C	75	A
±I <sub>CP</sub>	Collector Current (Peak)	T <sub>c</sub> = 25°C	150	A
P <sub>c</sub>	Collector Dissipation	T <sub>c</sub> = 25°C	390	W
T <sub>j</sub>	Junction Temperature		-20 ~ +150	°C

**CONVERTER PART**

Symbol	Parameter	Condition	Ratings	Unit
V <sub>CES</sub>	Collector-Emitter Voltage	V <sub>D</sub> = 15V, V <sub>CIN</sub> = 15V	600	V
I <sub>c</sub>	Collector Current	T <sub>c</sub> = 25°C	75	A
I <sub>CP</sub>	Collector Current (Peak)	T <sub>c</sub> = 25°C	150	A
P <sub>c</sub>	Collector Dissipation	T <sub>c</sub> = 25°C (Note-1)	390	W
I <sub>F</sub>	FWDi Forward Current	T <sub>c</sub> = 25°C	75	A
V <sub>R(DC)</sub>	FWDi Rated DC Reverse Voltage	T <sub>c</sub> = 25°C	600	V
T <sub>j</sub>	Junction Temperature		-20 ~ +150	°C

**CONTROL PART**

Symbol	Parameter	Condition	Ratings	Unit
V <sub>D</sub>	Supply Voltage	Applied between : V <sub>UP1</sub> -V <sub>UPC</sub> , V <sub>VP1</sub> -V <sub>VPC</sub> , V <sub>N1</sub> -V <sub>NC</sub>	20	V
V <sub>CIN</sub>	Input Voltage	Applied between : U <sub>P</sub> -V <sub>UPC</sub> , V <sub>P</sub> -V <sub>VPC</sub> , U <sub>N</sub> -V <sub>N</sub> • W <sub>N</sub> -V <sub>NC</sub>	20	V
V <sub>FO</sub>	Fault Output Supply Voltage	Applied between : U <sub>FO</sub> -V <sub>UPC</sub> , V <sub>FO</sub> -V <sub>VPC</sub> , F <sub>O</sub> -V <sub>NC</sub>	20	V
I <sub>FO</sub>	Fault Output Current	Sink current at U <sub>FO</sub> , V <sub>FO</sub> , F <sub>O</sub> terminals	20	mA

**PM75B5LB060**FLAT-BASE TYPE  
INSULATED PACKAGE**TOTAL SYSTEM**

Symbol	Parameter	Condition	Ratings	Unit
VCC(PROT)	Supply Voltage Protected by SC	VD = 13.5 ~ 16.5V, Inverter Part, $T_j = +125^\circ\text{C}$ Start	450	V
VCC(surge)	Supply Voltage (Surge)	Applied between : P-N, Surge value	500	V
Tstg	Storage Temperature		-40 ~ +125	°C
Viso	Isolation Voltage	60Hz, Sinusoidal, Charged part to Base, AC 1 min.	2500	Vrms

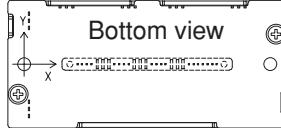
**THERMAL RESISTANCES**

Symbol	Parameter	Condition	Limits			Unit
			Min.	Typ.	Max.	
Rth(j-c)Q	Junction to case Thermal Resistances	Inverter IGBT part (per 1/4 module)	(Note-1)	—	—	0.32
Rth(j-c)F		Inverter FWDi part (per 1/4 module)	(Note-1)	—	—	0.53
Rth(j-c)Q		Converter IGBT part	(Note-1)	—	—	0.32
Rth(j-c)F		Converter FWDi upper part	(Note-1)	—	—	0.33
Rth(j-c)F		Converter FWDi lower part	(Note-1)	—	—	0.53
Rth(c-f)		Case to fin, (per 1 module) Thermal grease applied	(Note-1)	—	—	0.038

(Note-1)  $T_c$  (under the chip) measurement point is below.

(unit : mm)

axis \ arm	UP		VP		WP		UN		VN		WN	
	IGBT	FWDi	IGBT	FWDi	FWDi	IGBT	FWDi	IGBT	FWDi	IGBT	FWDi	
X	33.6	31.2	66.0	66.0	85.8	40.5	41.6	56.2	56.2	76.3	76.3	
Y	-7.5	4.5	-8.6	0.6	-3.1	8.0	0.0	2.7	-5.5	2.7	-6.5	

**ELECTRICAL CHARACTERISTICS ( $T_j = 25^\circ\text{C}$ , unless otherwise noted)****INVERTER PART**

Symbol	Parameter	Condition	Limits			Unit
			Min.	Typ.	Max.	
VCE(sat)	Collector-Emitter Saturation Voltage	VD = 15V, IC = 75A	$T_j = 25^\circ\text{C}$	—	1.7	2.3
		VCIN = 0V		(Fig. 1)	$T_j = 125^\circ\text{C}$	1.55 2.0
VEC	FWDi Forward Voltage	$-IC = 75\text{A}, VD = 15\text{V}, VCIN = 15\text{V}$	(Fig. 2)	—	2.2	3.3
ton	Switching Time	VD = 15V, VCIN = 0V $\leftrightarrow$ 15V VCC = 300V, IC = 75A $T_j = 125^\circ\text{C}$ Inductive Load	0.3	0.7	1.4	$\mu\text{s}$
trr			—	0.1	0.2	
tc(on)			—	0.2	0.4	
toff			—	0.9	1.8	
tc(off)			—	0.2	0.4	
ICES	Collector-Emitter Cutoff Current	VCE = VCES, VCIN = 15V	(Fig. 5)	$T_j = 25^\circ\text{C}$	—	1
				$T_j = 125^\circ\text{C}$	—	10
						mA

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FLAT-BASE TYPE  
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**CONVERTER PART**

Symbol	Parameter	Condition	Limits			Unit	
			Min.	Typ.	Max.		
V <sub>CE(sat)</sub>	Collector-Emitter Saturation Voltage	V <sub>D</sub> = 15V, I <sub>C</sub> = 75A V <sub>CIN</sub> = 0V, Pulsed (Fig. 1)	T <sub>j</sub> = 25°C T <sub>j</sub> = 125°C	— —	1.7 1.55	2.3 2.0	V
V <sub>EC</sub>	FWDi Forward Voltage	—I <sub>C</sub> = 75A, V <sub>CIN</sub> = 15V, V <sub>D</sub> = 15V	(Fig. 2)	—	2.2	3.3	V
V <sub>FM</sub>	Forward Voltage	I <sub>F</sub> = 75A		—	1.9	3.0	V
t <sub>on</sub>	Switching Time	V <sub>D</sub> = 15V, V <sub>CIN</sub> = 0V↔15V V <sub>CC</sub> = 300V, I <sub>C</sub> = 75A T <sub>j</sub> = 125°C Inductive Load	(Fig. 3,4)	0.3	0.7	1.4	μs
t <sub>rr</sub>				—	0.1	0.2	
t <sub>c(on)</sub>				—	0.2	0.4	
t <sub>off</sub>				—	0.9	1.8	
t <sub>c(off)</sub>				—	0.2	0.4	
I <sub>CES</sub>	Collector-Emitter Cutoff Current	V <sub>CE</sub> = V <sub>CES</sub> , V <sub>D</sub> = 15V	(Fig. 5)	T <sub>j</sub> = 25°C T <sub>j</sub> = 125°C	— —	1 10	mA

**CONTROL PART**

Symbol	Parameter	Condition	Limits			Unit	
			Min.	Typ.	Max.		
I <sub>D</sub>	Circuit Current	V <sub>D</sub> = 15V, V <sub>CIN</sub> = 15V	V <sub>N1</sub> -V <sub>NC</sub> V <sup>*</sup> P <sub>1</sub> -V <sup>*</sup> PC	— —	20 6	30 12	mA
V <sub>th(ON)</sub>	Input ON Threshold Voltage	Applied between : UP-VUPC, VP-VVPC	1.2	1.5	1.8	V	
V <sub>th(OFF)</sub>	Input OFF Threshold Voltage	UN • VN • WN-VNC	1.7	2.0	2.3		
S <sub>C</sub>	Short Circuit Trip Level	—20 ≤ T <sub>j</sub> ≤ 125°C, V <sub>D</sub> = 15V (Fig. 3,6)	Inverter part Converter part	150 150	— —	A	
t <sub>off(SC)</sub>	Short Circuit Current Delay Time	V <sub>D</sub> = 15V (Fig. 3,6)		—	0.2	—	μs
O <sub>T</sub>	Over Temperature Protection	V <sub>D</sub> = 15V Detect T <sub>j</sub> of IGBT chip	Trip level Reset level	135 —	145 125	—	°C
U <sub>V</sub>			Trip level Reset level	11.5 —	12.0 12.5	—	
U <sub>Vr</sub>	Supply Circuit Under-Voltage Protection	—20 ≤ T <sub>j</sub> ≤ 125°C		—	12.5	—	V
I <sub>FO(H)</sub>	Fault Output Current	V <sub>D</sub> = 15V, V <sub>FO</sub> = 15V	(Note-2)	— —	— 10	0.01 15	mA
I <sub>FO(L)</sub>				—	1.0	1.8	
t <sub>FO</sub>	Minimum Fault Output Pulse Width	V <sub>D</sub> = 15V	(Note-2)	1.0	1.8	—	ms

(Note-2) Fault output is given only when the internal SC, OT & UV protections schemes of either upper or lower arm device operate to protect it.

**MECHANICAL RATINGS AND CHARACTERISTICS**

Symbol	Parameter	Condition	Limits			Unit	
			Min.	Typ.	Max.		
—	Mounting torque	Mounting part	screw : M5	2.5	3.0	3.5	N • m
—	Weight	—	—	340	—	g	

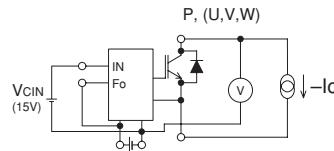
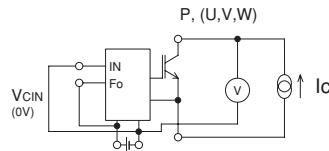
**RECOMMENDED CONDITIONS FOR USE**

Symbol	Parameter	Condition	Recommended value	Unit
V <sub>CC</sub>	Supply Voltage	Applied across P-N terminals	≤ 450	V
V <sub>D</sub>	Control Supply Voltage	Applied between : V <sub>UP1</sub> -V <sub>UPC</sub> , V <sub>VP1</sub> -V <sub>VPC</sub> V <sub>N1</sub> -V <sub>NC</sub> (Note-3)	15 ± 1.5	V
V <sub>CIN(ON)</sub>	Input ON Voltage	Applied between : UP-VUPC, VP-VVPC	≤ 0.8	V
V <sub>CIN(OFF)</sub>	Input OFF Voltage	UN • VN • WN-VNC	≥ 9.0	
f <sub>PWM</sub>	PWM Input Frequency	Using Application Circuit of Fig. 8	≤ 20	kHz
t <sub>dead</sub>	Arm Shoot-through Blocking Time	For IPM's each input signals (Fig. 7)	≥ 2.0	μs

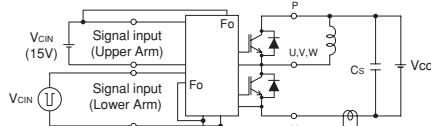
(Note-3) With ripple satisfying the following conditions : dv/dt swing ≤ ±5V/μs, Variation ≤ 2V peak to peak

**PRECAUTIONS FOR TESTING**

- Before applying any control supply voltage ( $V_D$ ), the input terminals should be pulled up by resistors, etc. to their corresponding supply voltage and each input signal should be kept off state.  
After this, the specified ON and OFF level setting for each input signal should be done.
- When performing "SC" tests, the turn-off surge voltage spike at the corresponding protection operation should not be allowed to rise above  $V_{CES}$  rating of the device.  
(These test should not be done by using a curve tracer or its equivalent.)



a) Lower Arm Switching



b) Upper Arm Switching

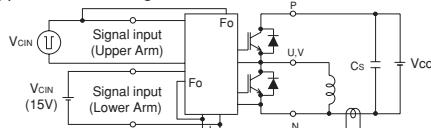


Fig. 3 Switching Time and SC Test Circuit

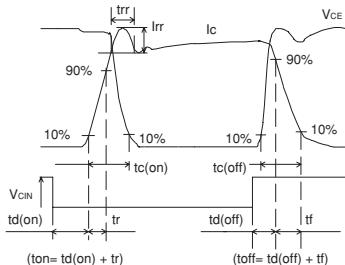


Fig. 4 Switching Time Test Waveform

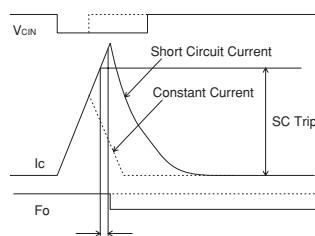
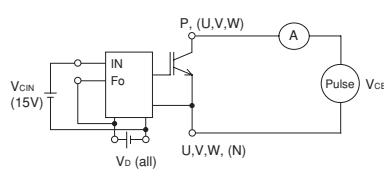
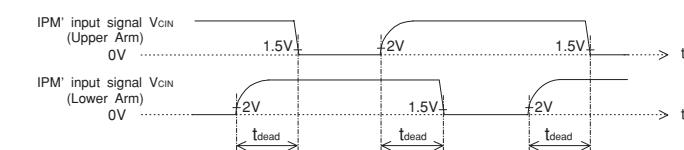


Fig. 6 SC Test Waveform



1.5V: Input on threshold voltage  $V_{th(on)}$  typical value, 2V: Input off threshold voltage  $V_{th(off)}$  typical value

Fig. 7 Dead Time Measurement Point Example

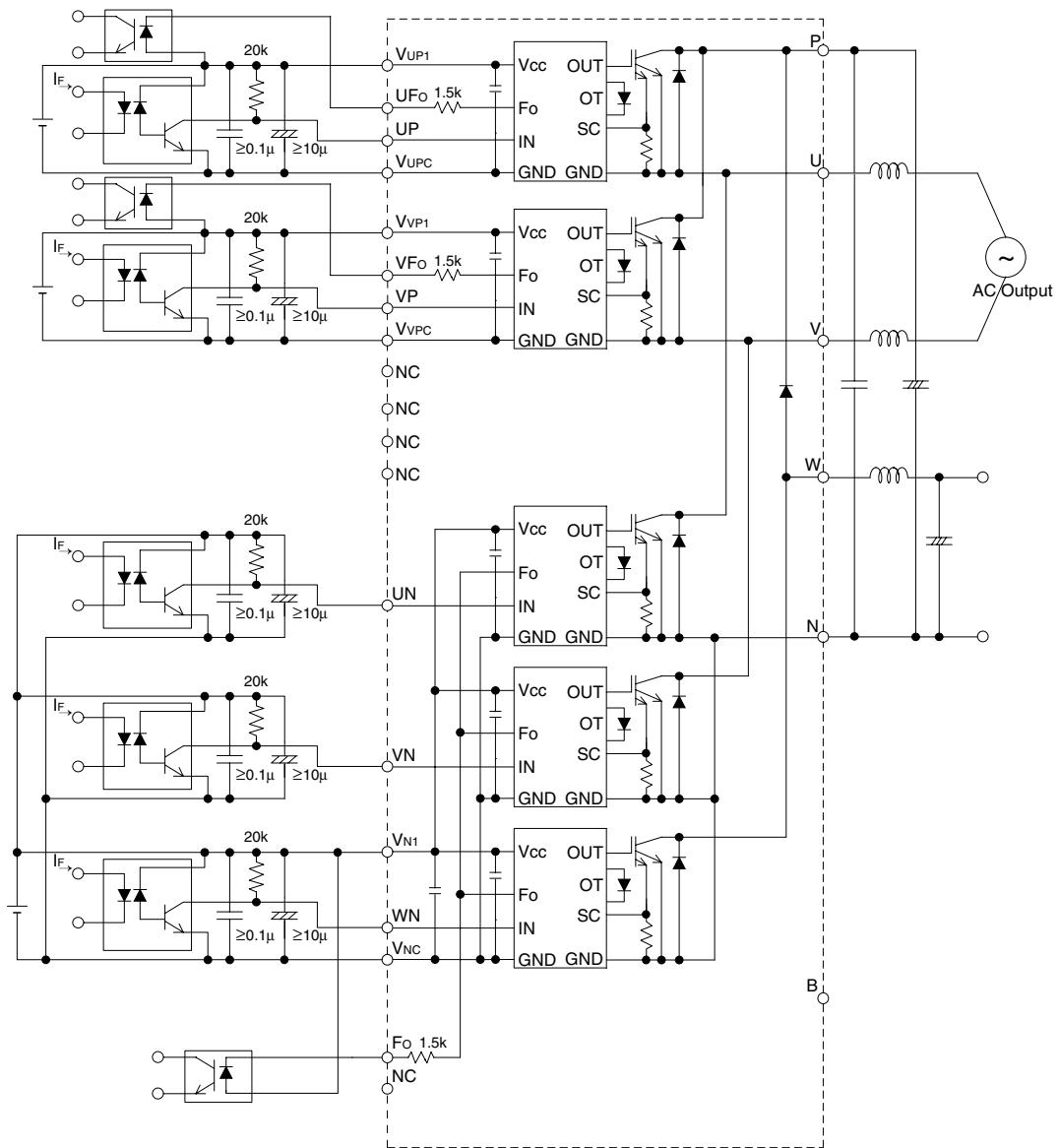
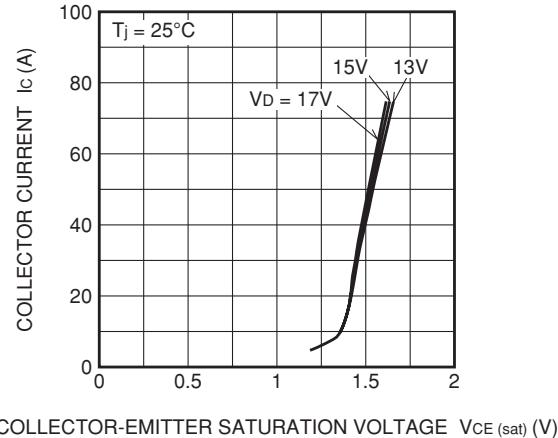
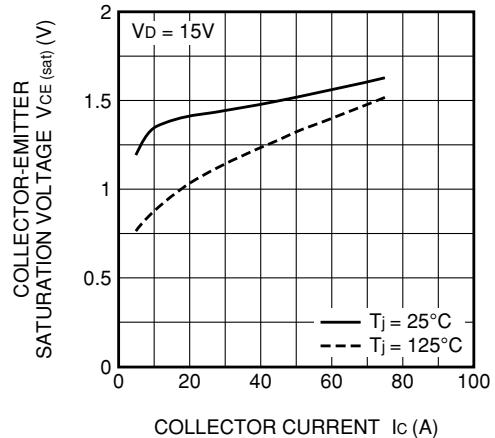
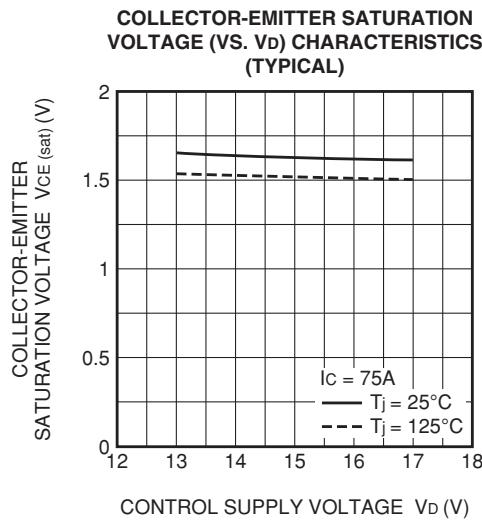
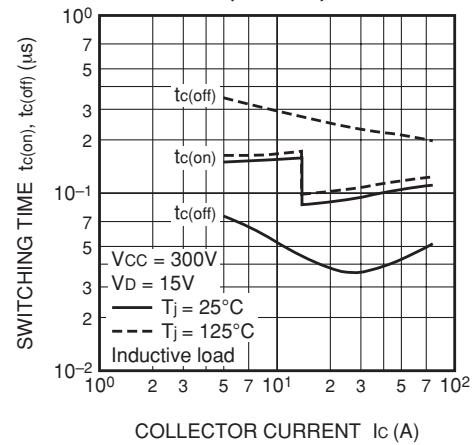
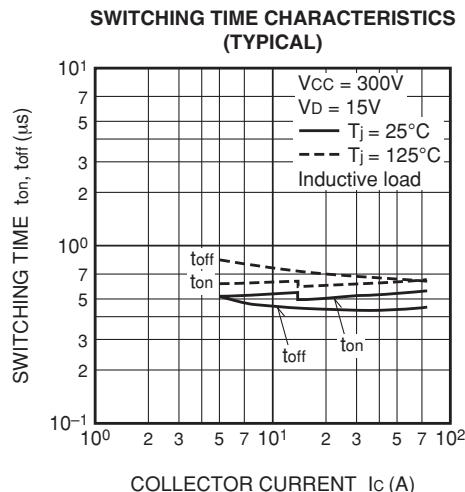
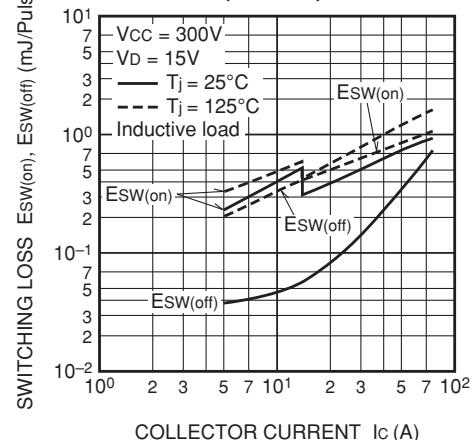
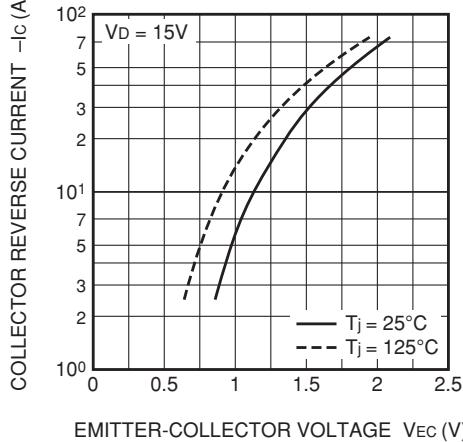
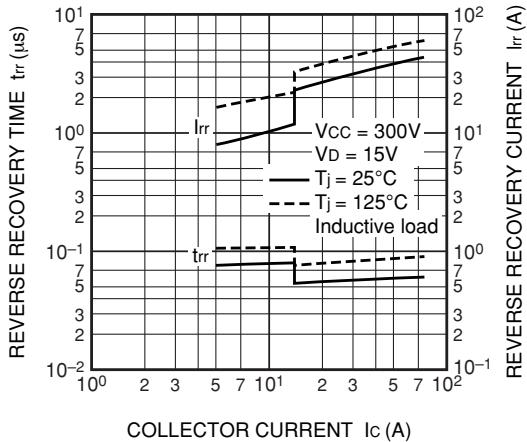
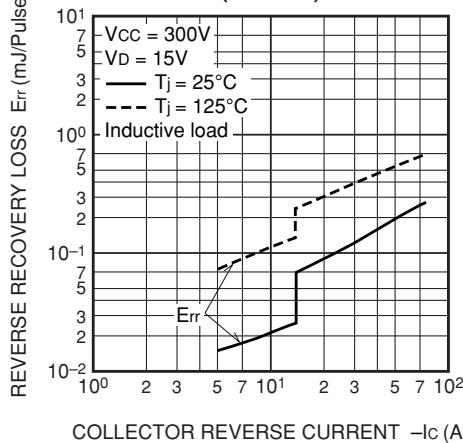
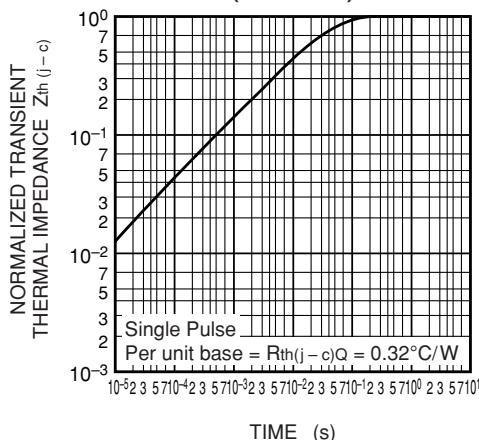


Fig. 8 Application Example Circuit

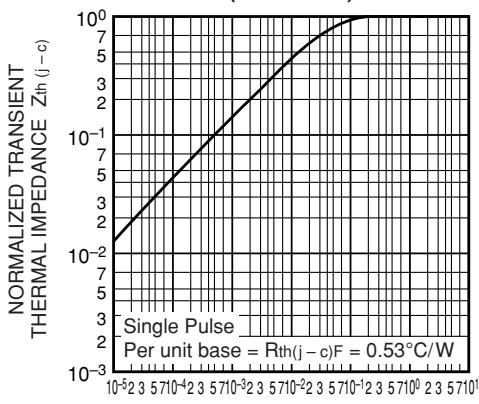
**NOTES FOR STABLE AND SAFE OPERATION :**

- Design the PCB pattern to minimize wiring length between opto-coupler and IPM's input terminal, and also to minimize the stray capacity between the input and output wirings of opto-coupler.
- Connect low impedance capacitor between the Vcc and GND terminal of each fast switching opto-coupler.
- Fast switching opto-couplers:  $t_{PLH}, t_{PHL} \leq 0.8\mu s$ , Use High CMR type.
- Slow switching opto-coupler: CTR > 100%
- Use 3 isolated control power supplies ( $V_D$ ). Also, care should be taken to minimize the instantaneous voltage charge of the power supply.
- Make inductance of DC bus line as small as possible, and minimize surge voltage using snubber capacitor between P and N terminal.

**PERFORMANCE CURVES (INVERTER PART)****OUTPUT CHARACTERISTICS  
(TYPICAL)****COLLECTOR-EMITTER SATURATION  
VOLTAGE (VS.  $I_c$ ) CHARACTERISTICS  
(TYPICAL)**COLLECTOR-EMITTER SATURATION VOLTAGE  $V_{CE(sat)}$  (V)COLLECTOR CURRENT  $I_c$  (A)**SWITCHING TIME CHARACTERISTICS  
(TYPICAL)**COLLECTOR CURRENT  $I_c$  (A)**SWITCHING LOSS CHARACTERISTICS  
(TYPICAL)**COLLECTOR CURRENT  $I_c$  (A)

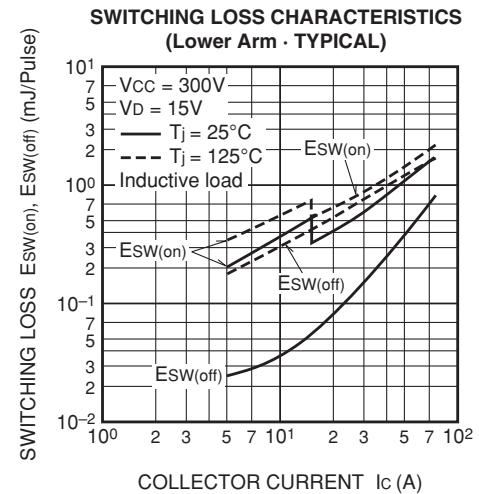
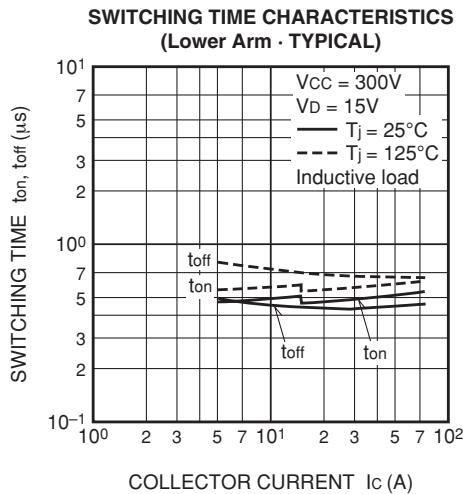
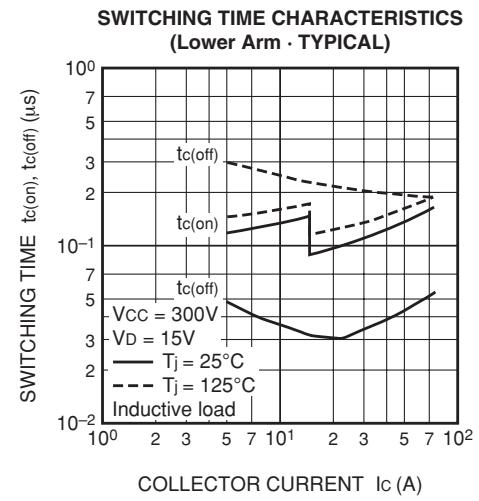
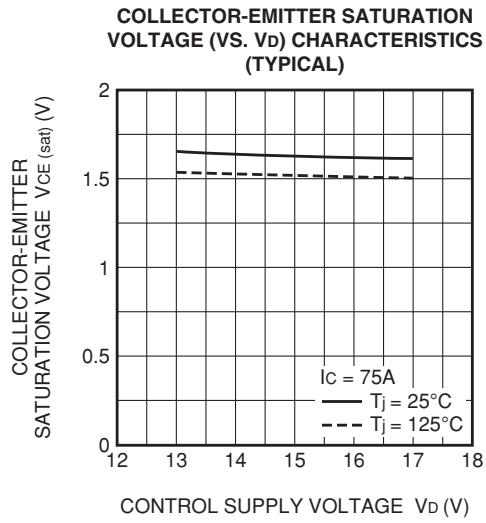
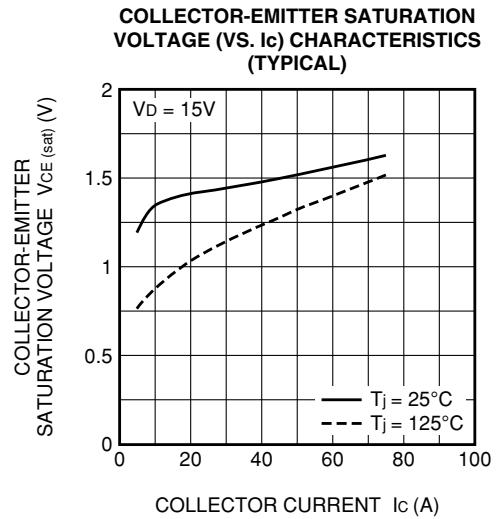
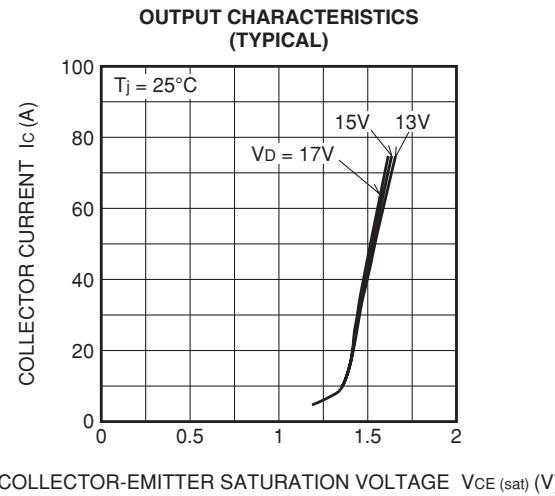
**PM75B5LB060**FLAT-BASE TYPE  
INSULATED PACKAGEFWDi FORWARD VOLTAGE CHARACTERISTICS  
(TYPICAL)EMITTER-COLLECTOR VOLTAGE  $V_{EC}$  (V)FWDi REVERSE RECOVERY CHARACTERISTICS  
(TYPICAL)COLLECTOR CURRENT  $I_C$  (A)FWDi REVERSE RECOVERY LOSS CHARACTERISTICS  
(TYPICAL)COLLECTOR REVERSE CURRENT  $-I_C$  (A)TRANSIENT THERMAL  
IMPEDANCE CHARACTERISTICS  
(IGBT PART)

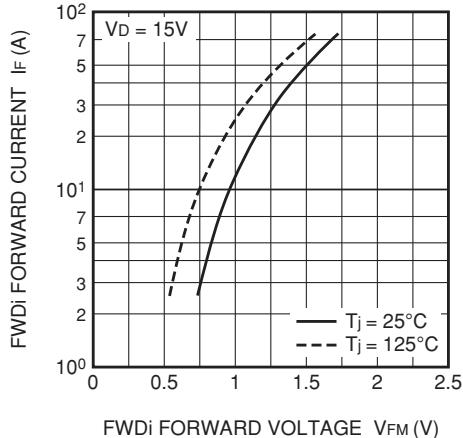
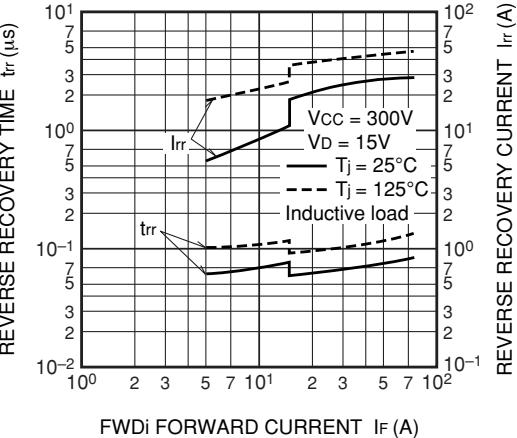
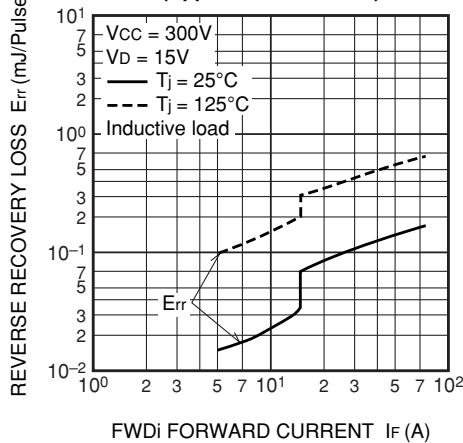
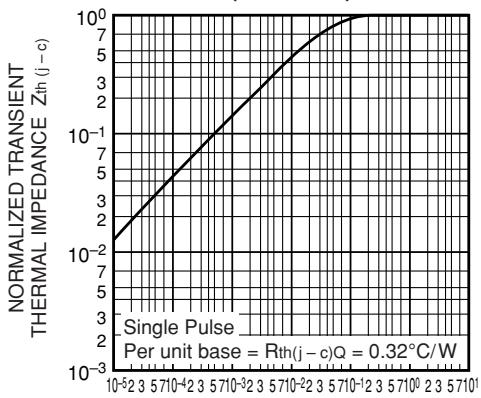
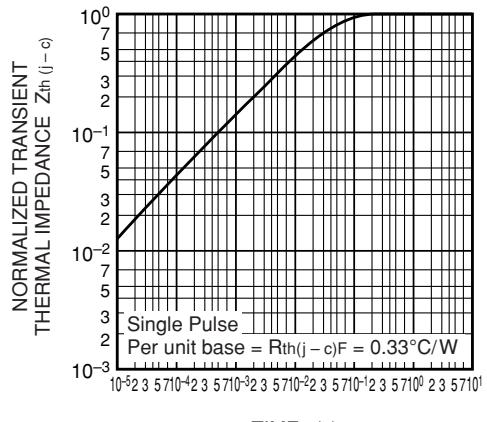
TIME (s)

TRANSIENT THERMAL  
IMPEDANCE CHARACTERISTICS  
(FWDi PART)

**PM75B5LB060**FLAT-BASE TYPE  
INSULATED PACKAGE

## (CONVERTER PART)



**PM75B5LB060**FLAT-BASE TYPE  
INSULATED PACKAGEFWD<sub>i</sub> FORWARD VOLTAGE CHARACTERISTICS  
(Upper Arm · TYPICAL)FWD<sub>i</sub> REVERSE RECOVERY CHARACTERISTICS  
(Upper Arm · TYPICAL)FWD<sub>i</sub> REVERSE RECOVERY LOSS CHARACTERISTICS  
(Upper Arm · TYPICAL)TRANSIENT THERMAL  
IMPEDANCE CHARACTERISTICS  
(IGBT PART)TRANSIENT THERMAL  
IMPEDANCE CHARACTERISTICS  
(FWD<sub>i</sub> PART · Upper Arm)TRANSIENT THERMAL  
IMPEDANCE CHARACTERISTICS  
(FWD<sub>i</sub> PART · Lower Arm)